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U.S. PATENT & TRADEMARK OFFICE

TRANSMITTAL LETTER  
(General - Patent Pending)

Docket No.  
E0520CIP

PATENT & TRADEMARK OFFICE  
Application Of: Kashmir S. Sahota, Diana M. Schonauer, Johannes F. Groschopf, Gerd F.C. Marxsen, Steven A. Avanzino

Serial No.  
09/749,191

Filing Date  
December 26, 2000

Examiner  
L. Umez-Eronini

Group Art Unit  
1765

Title: "PREVENTION OF PRECIPITATION DEFECTS ON COPPER INTERCONNECTS DURING CMP BY USE OF SOLUTIONS CONTAINING ORGANIC COMPOUNDS WITH SILICA ADSORPTION AND COPPER CORROSION INHIBITING PROPERTIES"

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is:

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01-0365

in the above identified application.

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Deborah W. Wenocur  
Signature

Dated: March 18, 2003

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I certify that this document and fee is being deposited on March 18, 2003 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

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